

LED: Critical Research Issues

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**SMART
LIGHTING**



Rensselaer

DOE Solid State Lighting
R&D Workshop
Long Beach, CA

why not change the world?"

January 30, 2013



NYSTAR



C. Wetzel

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CW 2012-00-18 1951.c

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Materials Development Needs

- Droop Reduction
 - => Higher Efficiency
 - => Higher Lumen
 - => Less Cooling
- Integration LED + Phosphor
 - => Direct Spectrum LED
- Integration LED + Driver + Sensor + Controls
 - => AC LED System

New Ideas on How to Avoid Droop

APPLIED PHYSICS LETTERS **102**, 031120 (2013)

Suppression of Auger-stimulated efficiency droop in nitride-based light emitting diodes

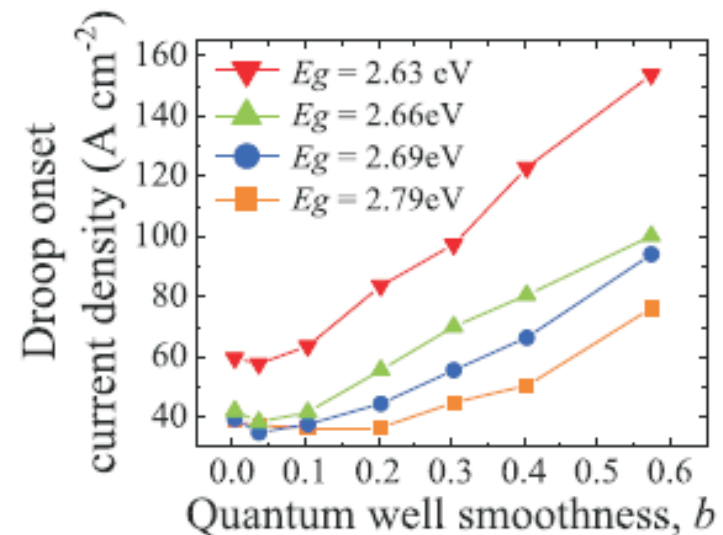
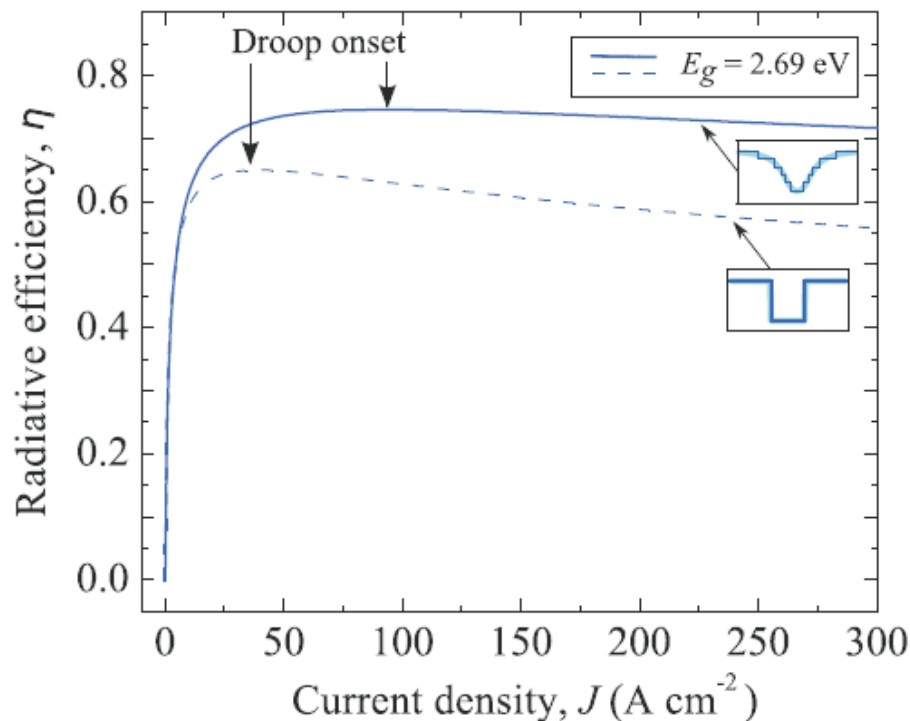
R. Vaxenburg,¹ E. Lifshitz,¹ and A. L. Efros²

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²*Naval Research Laboratory, Washington, District of Columbia 20375, USA*



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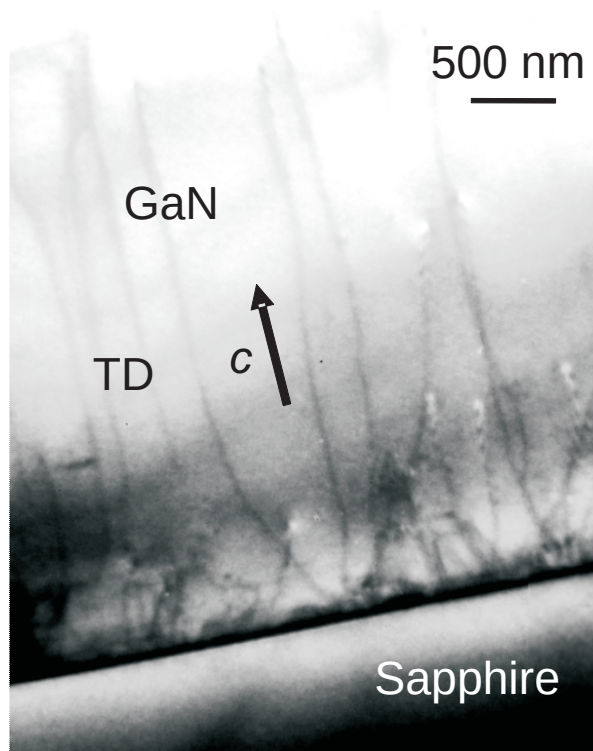


New ideas — need to be tested

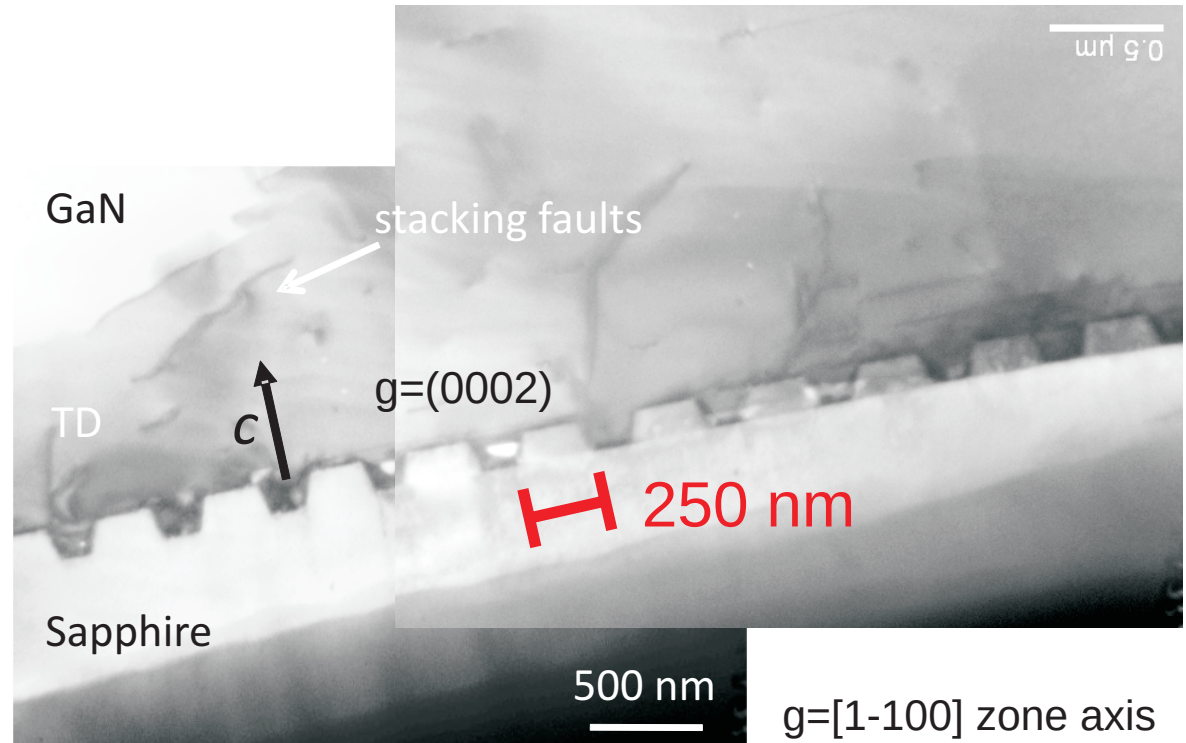
GaN on Nano-Patterned Sapphire

profound change in defect structure

reference LED



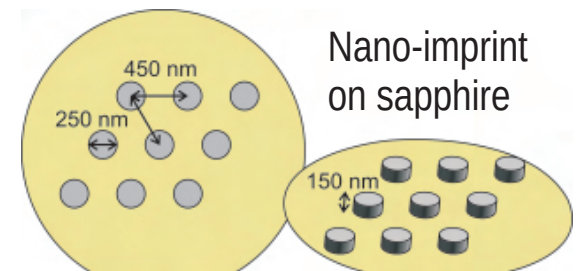
LED on nanopatterned substrate



TD density (plan view TEM):

$$6.4 \times 10^8 \text{ cm}^{-2}$$

$$<< 3.6 \times 10^8 \text{ cm}^{-2} \quad \downarrow -44\%$$



AIP Applied Physics Letters

Yufeng Li, et al. Appl. Phys. Lett, **98**(15), 151102 (2011). doi:10.1063/1.3579255

C. Wetzel

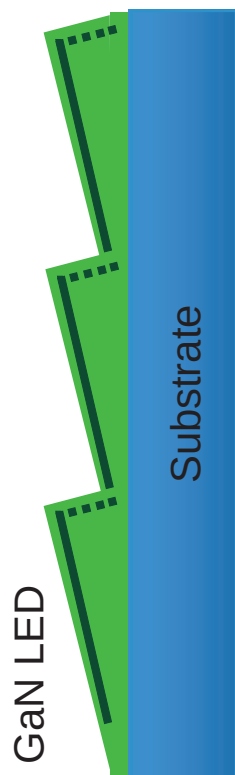
CW 2012-06-09 1138.c

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Epitaxy on Large Surface Miscut – Built-In Patterning

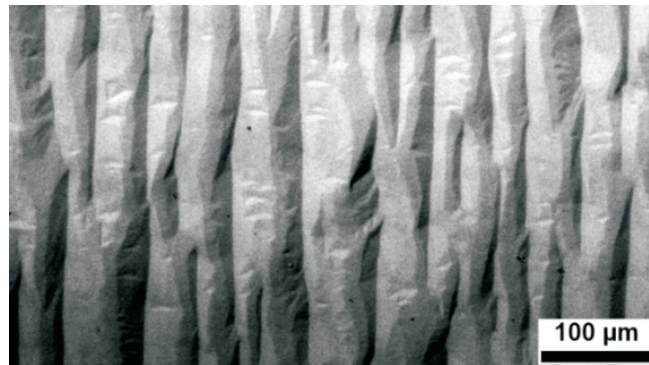
the art of light extraction

Entire LEDs in
fish scale pattern

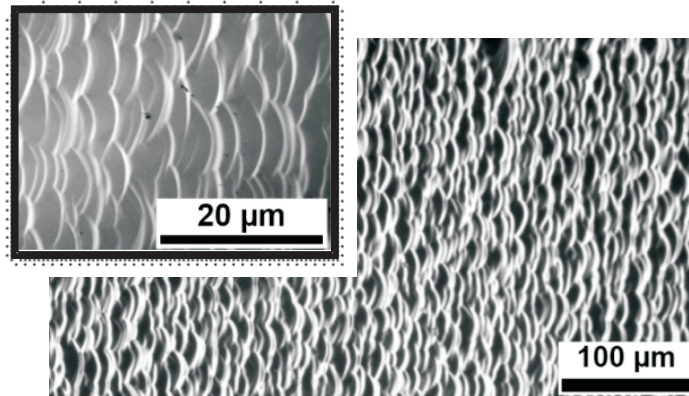
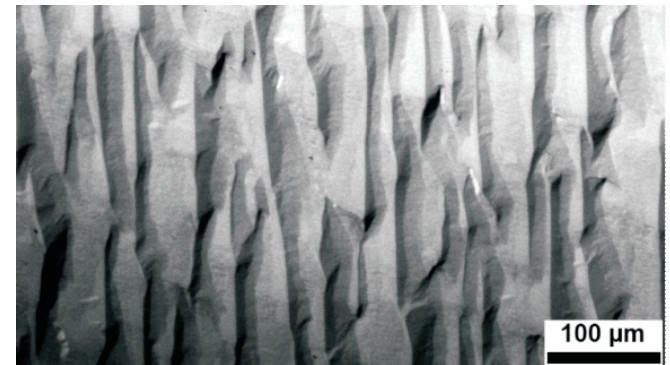


GaN substrate miscut (deg)

0.06° GaN

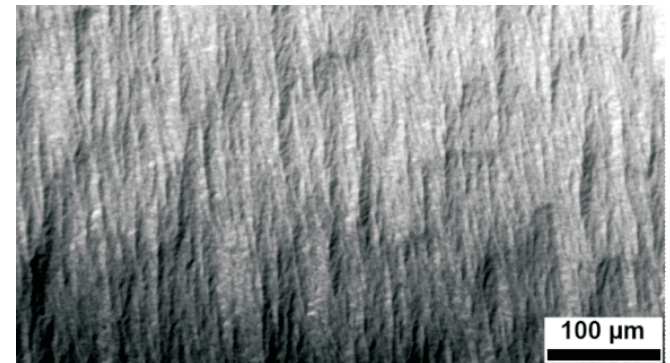


0.70° GaN



2.24° GaN

0.25° Sapphire



LED surface image

Droop Reduction

Bulk GaN

homoepitaxy

New QWs

new profile

new alloy

Semipolar

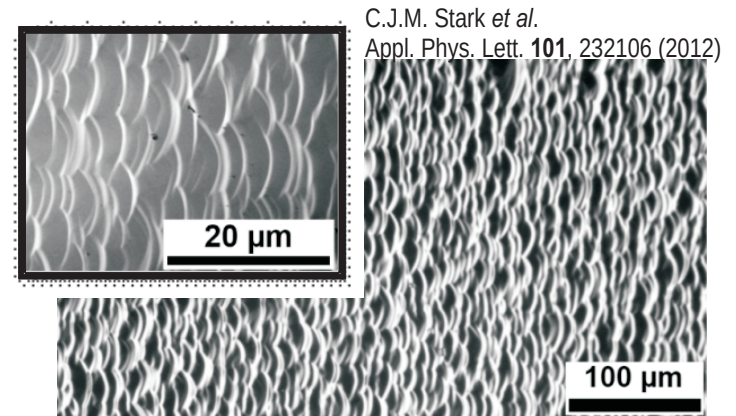
substrate

epitaxy

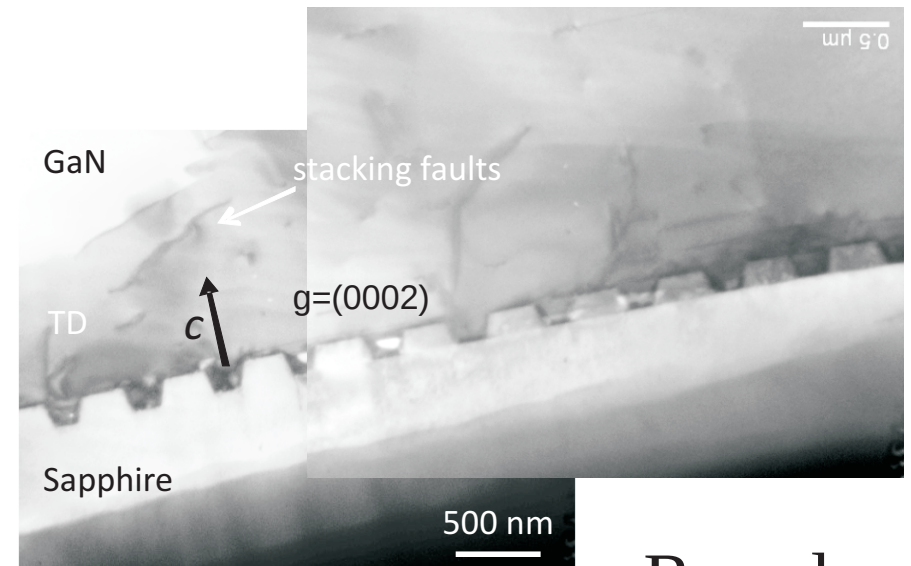
Nano-patterned

Si substrate

new substrates



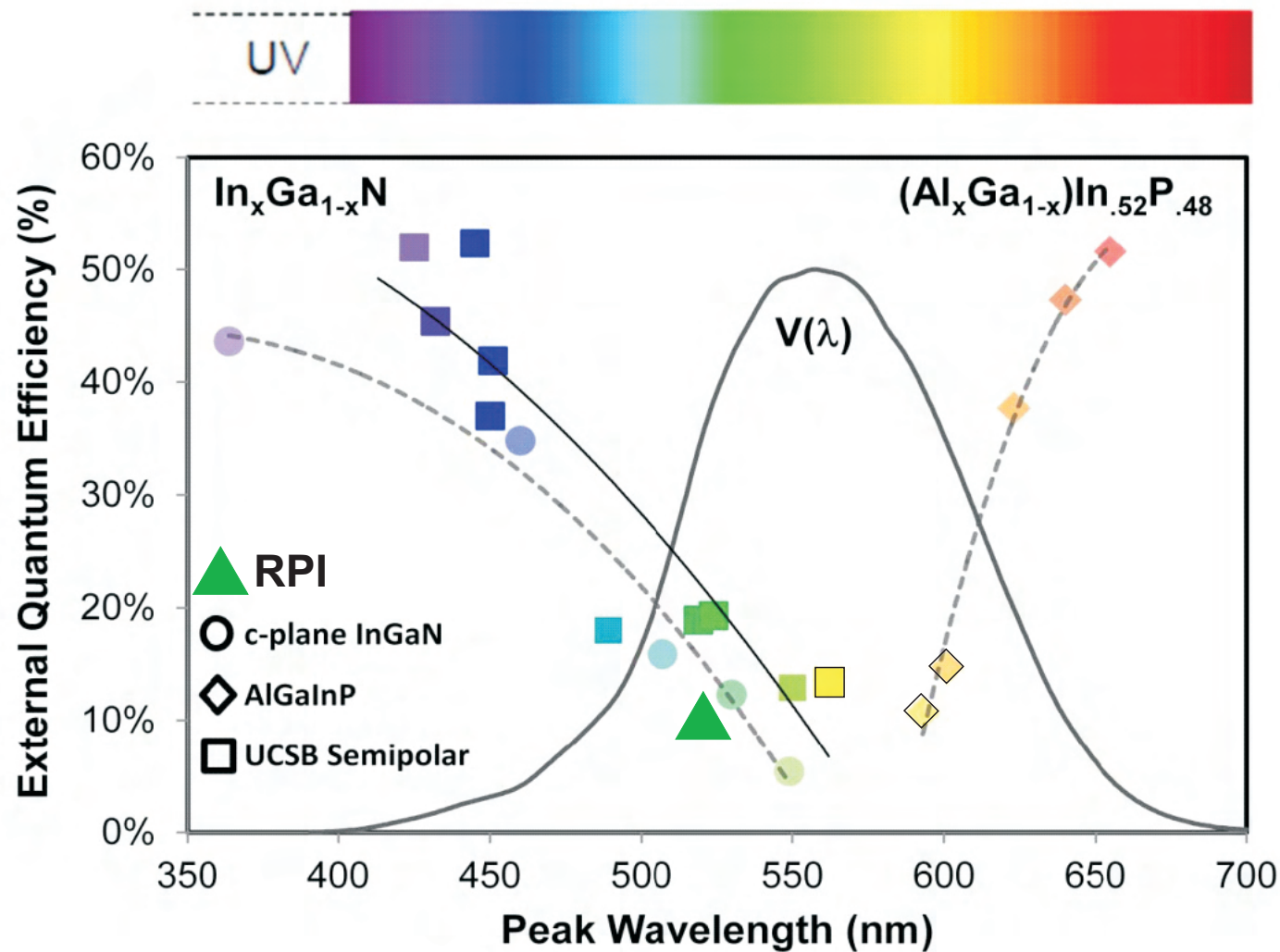
2.24° GaN



Yufeng Li, *et al.* Appl. Phys. Lett. **98**(15), 151102 (2011)

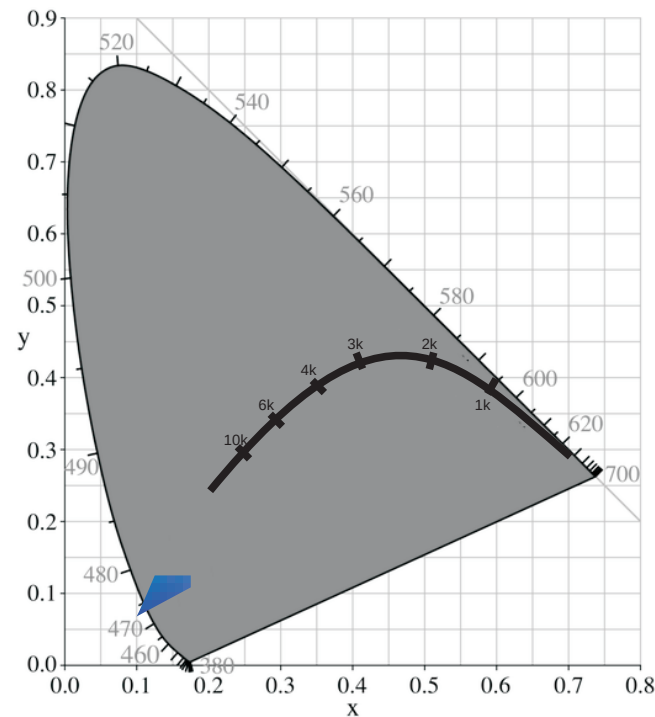
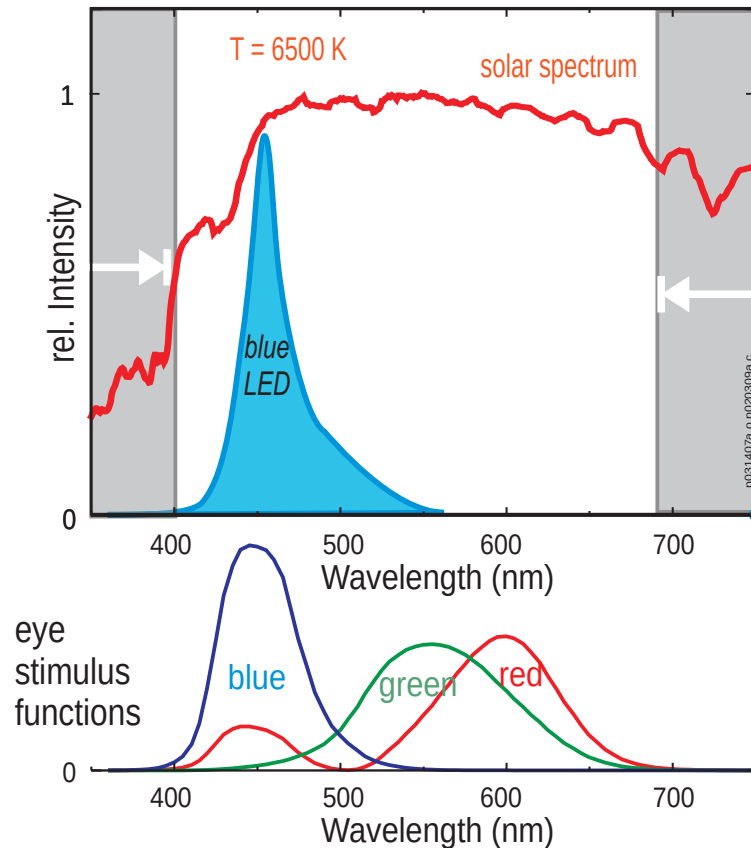
The Green Gap

window of opportunity

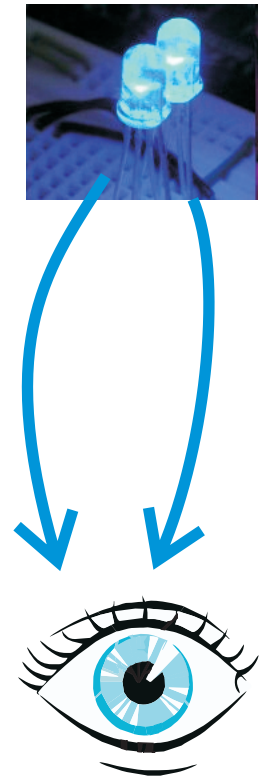


Composite White Light Emitting Diode

blue plus phosphor

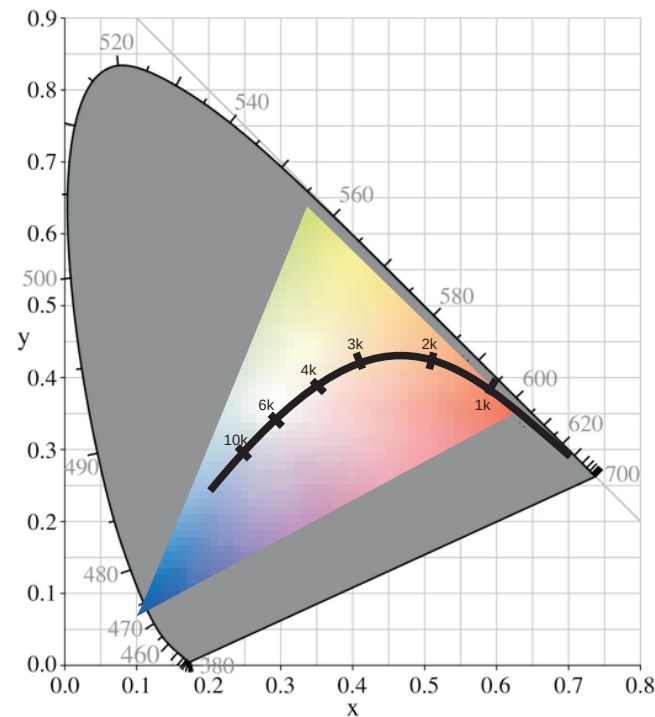
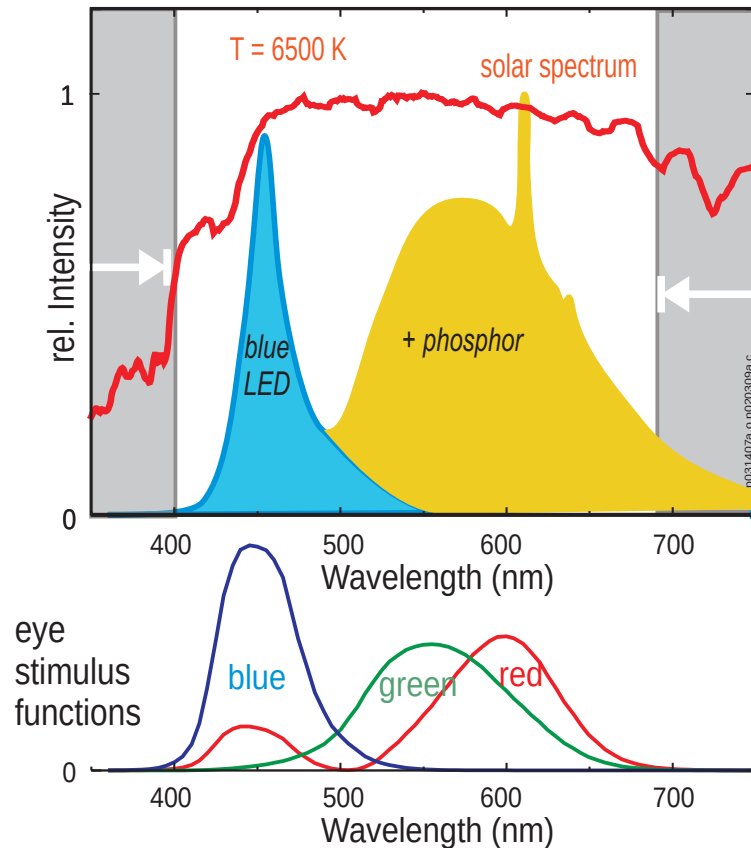


1931 Chromaticity Diagram



Composite White Light Emitting Diode

blue plus phosphor

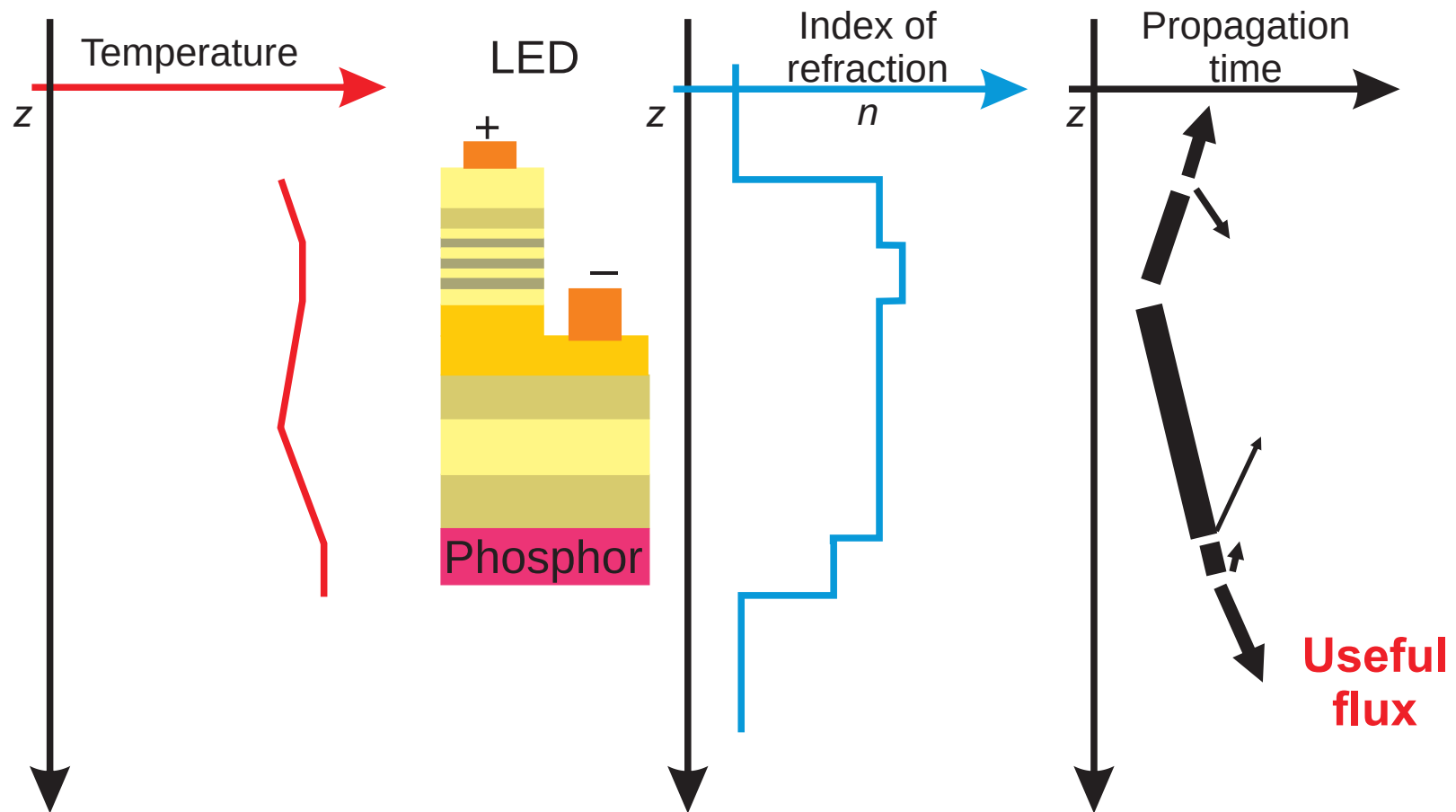


1931 Chromaticity Diagram



Proper Placement of Phosphor Layer

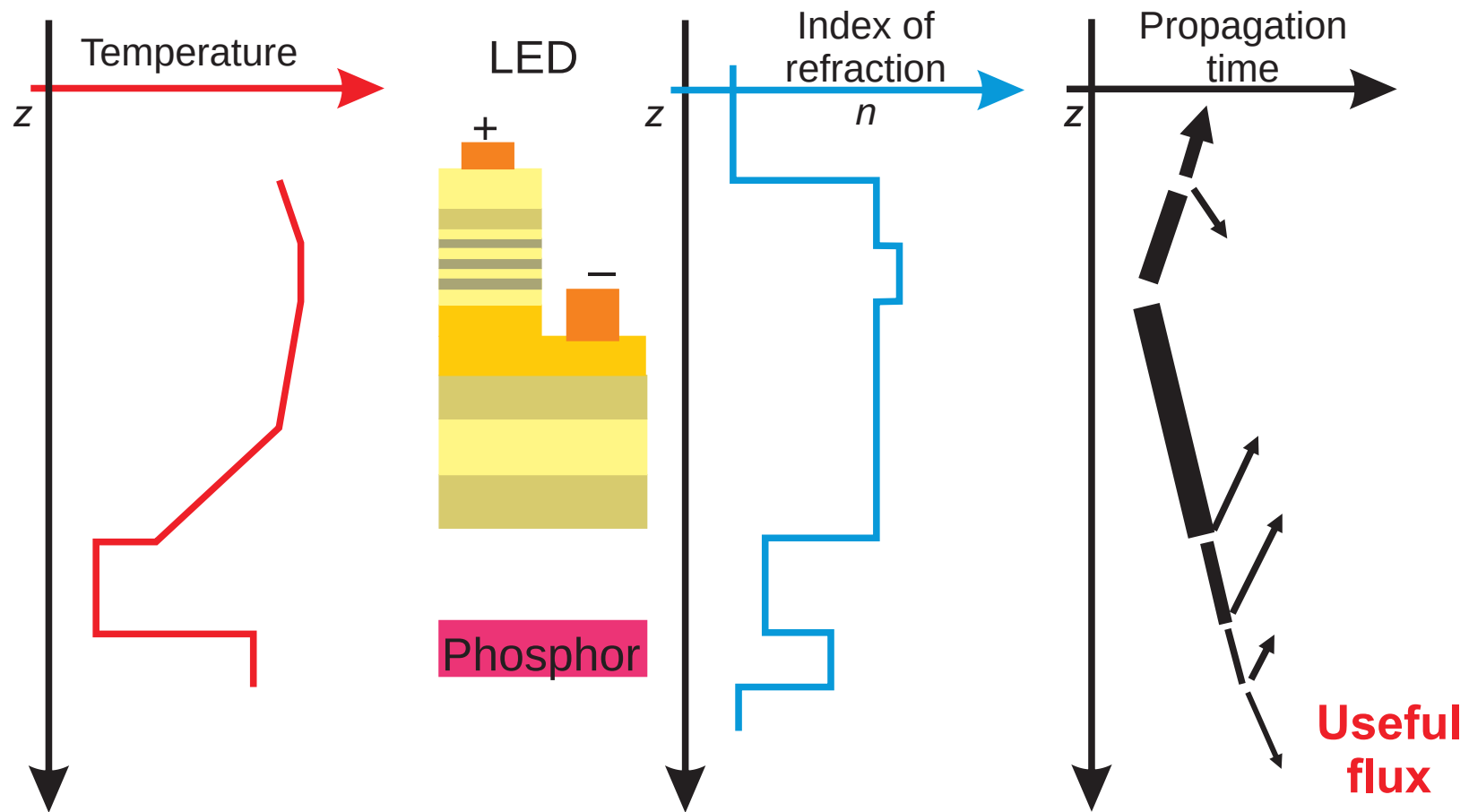
index and thermal matching



sandwiched phosphor — too hot of for standard phosphor

Proper Placement of Phosphor Layer

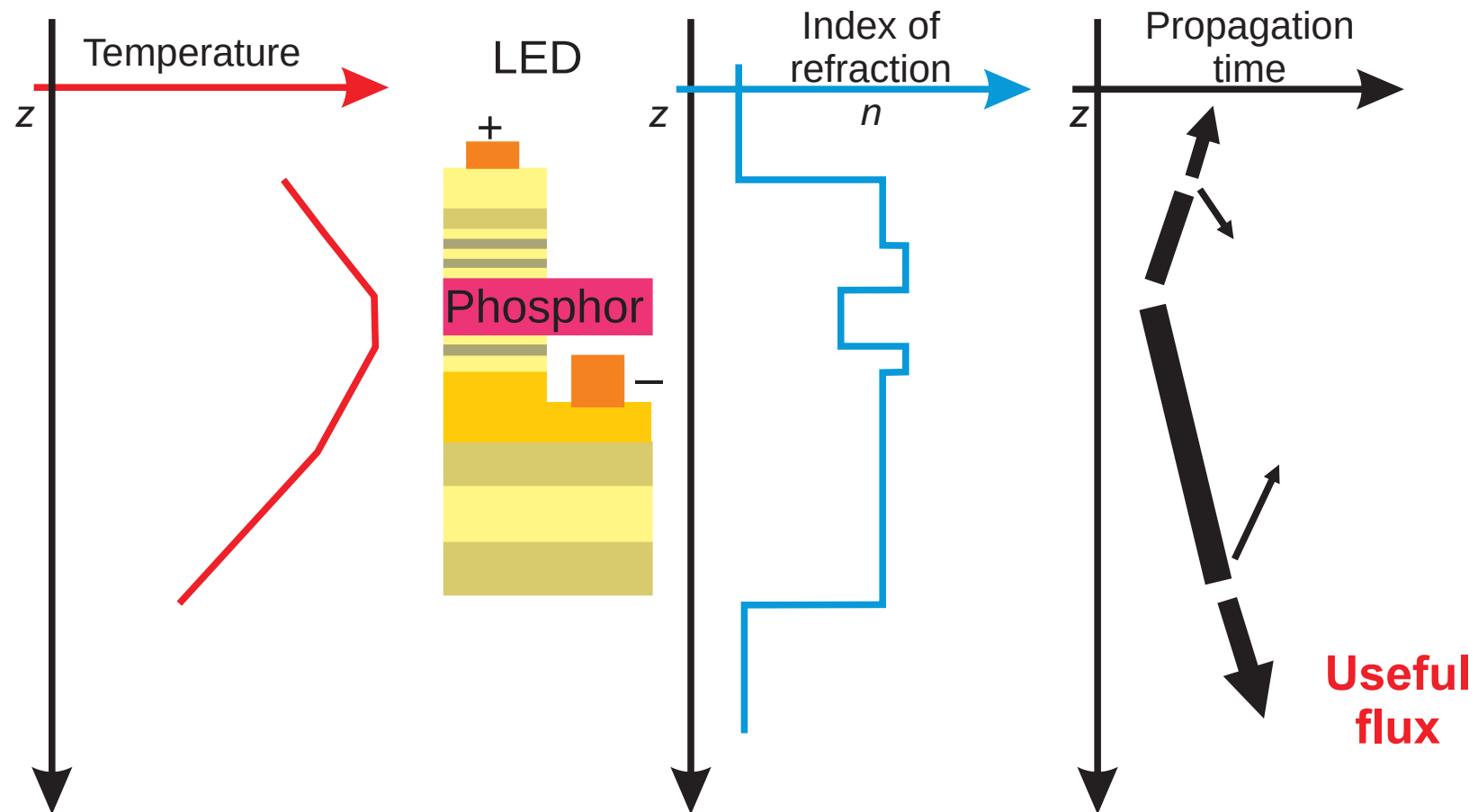
index and thermal matching



remote phosphor — high light coupling losses

Proper Placement of Phosphor Layer

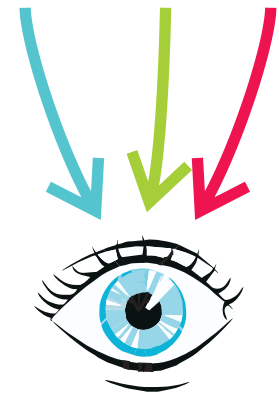
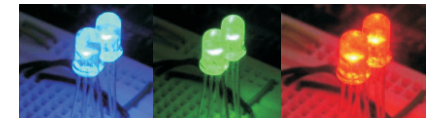
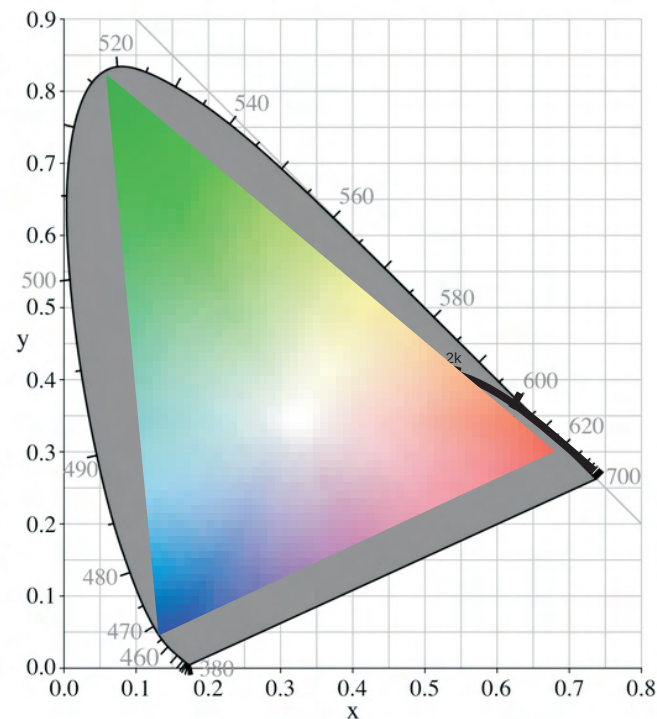
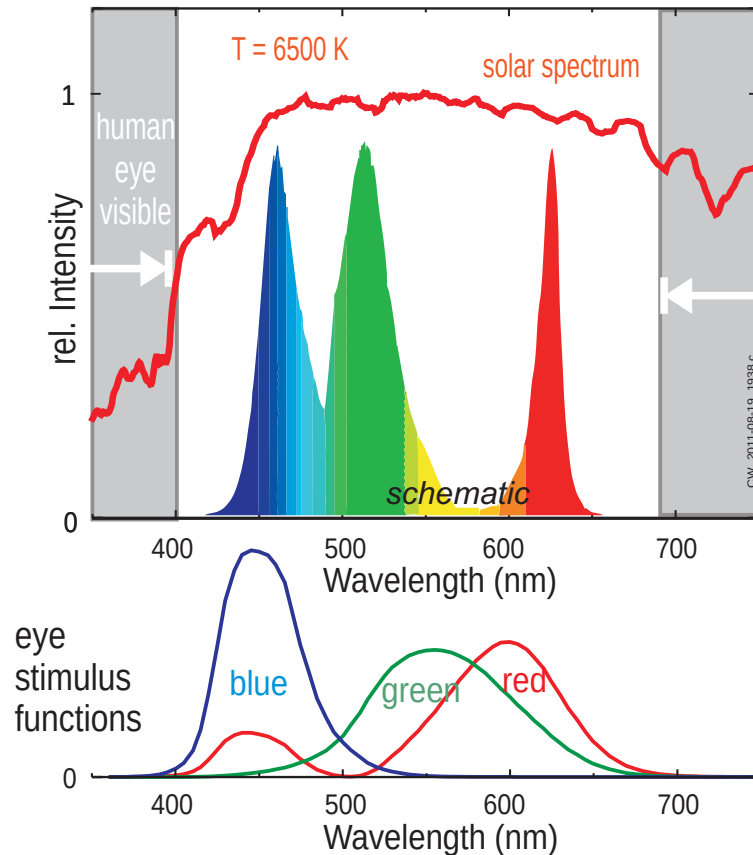
index and thermal matching



*phosphor in source — highest possible flux
need epi compatible*

Composite White Light Emitting Diode

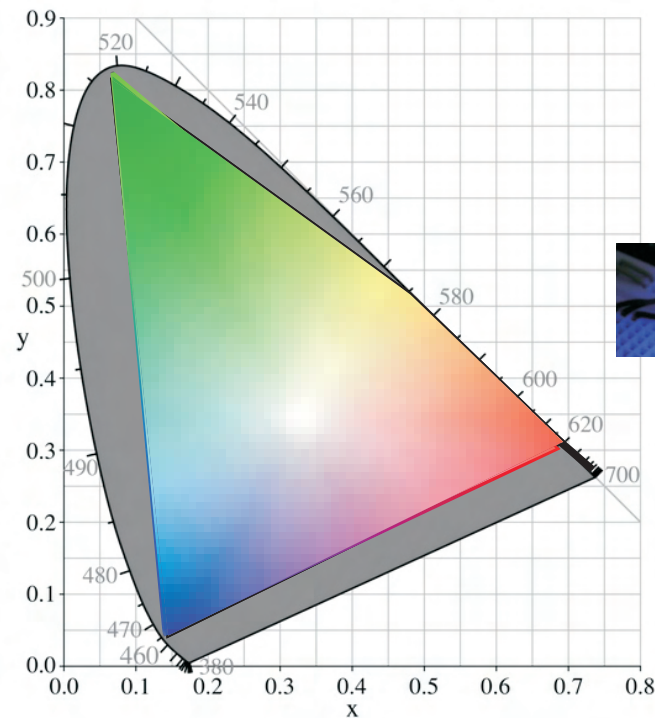
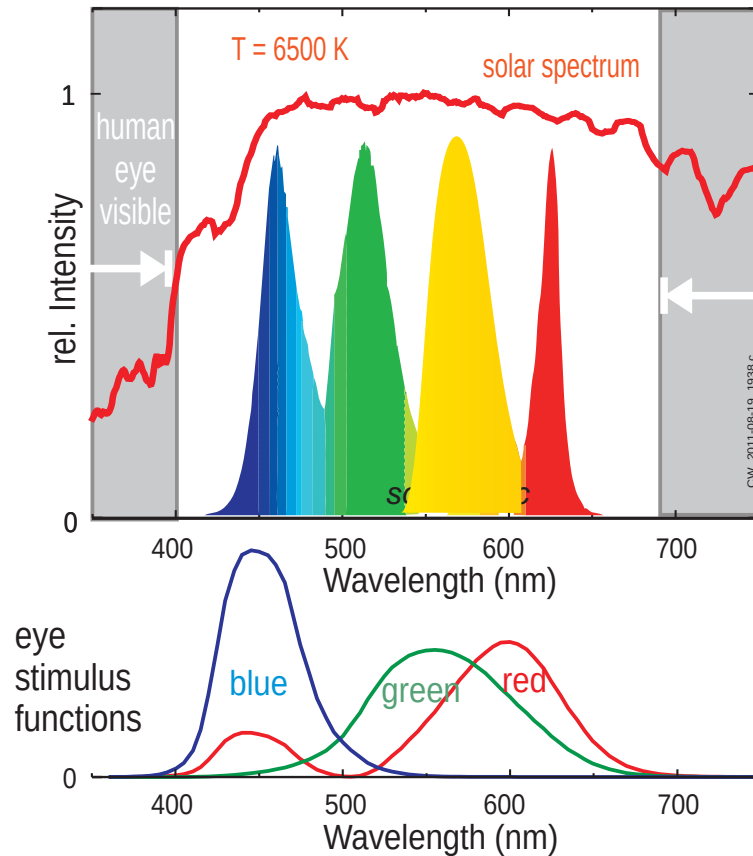
RGB LED



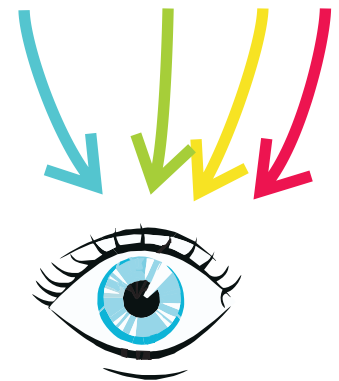
1931 Chromaticity Diagram

Composite White Light Emitting Diode

RGBY LED



1931 Chromaticity Diagram



Direct Spectrum LED

keep it semiconductor

Green, Yellow Red

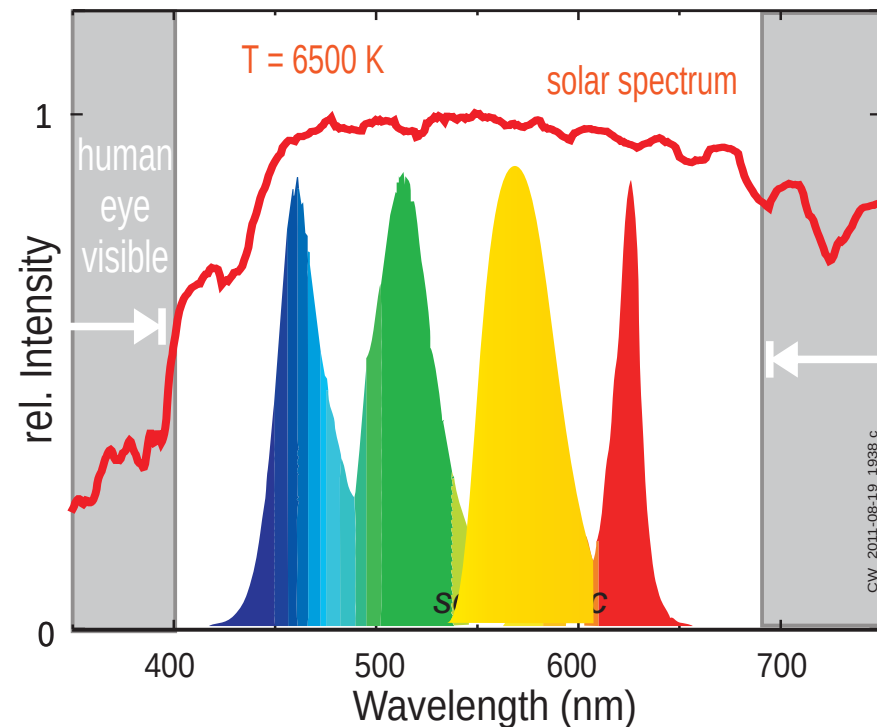
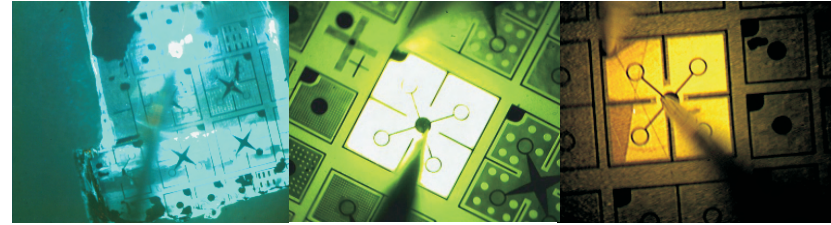
rare earth free
phosphor free
index matched
InGaN or some new alloy

Individual RGBY

semipolar
bulk GaN-based

Multicolored RGBY

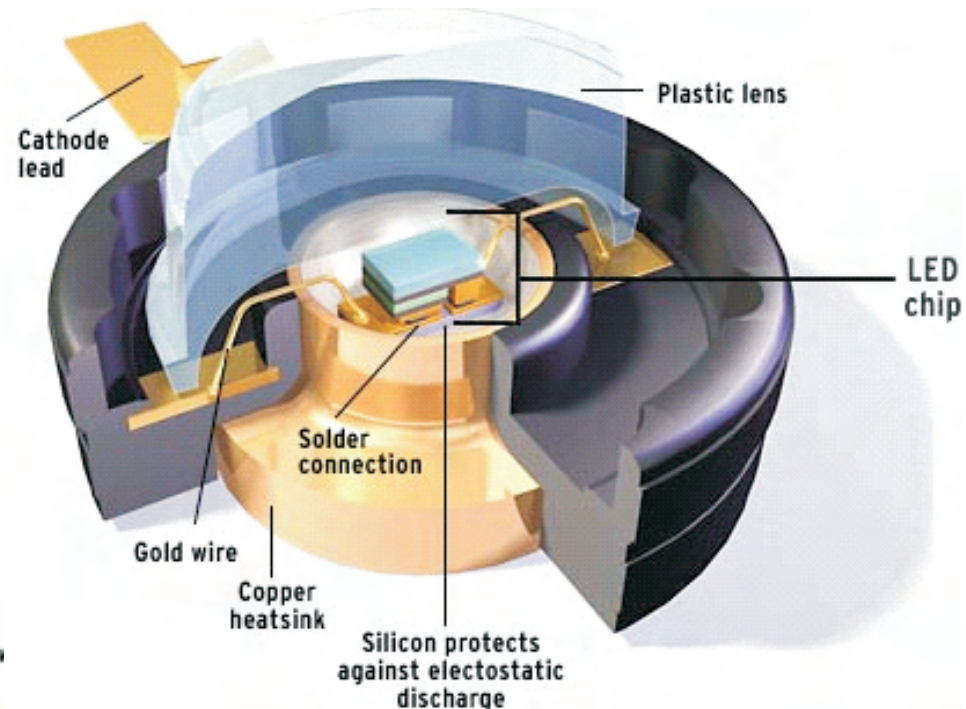
microstructured
nanostructured



Luxeon White LED

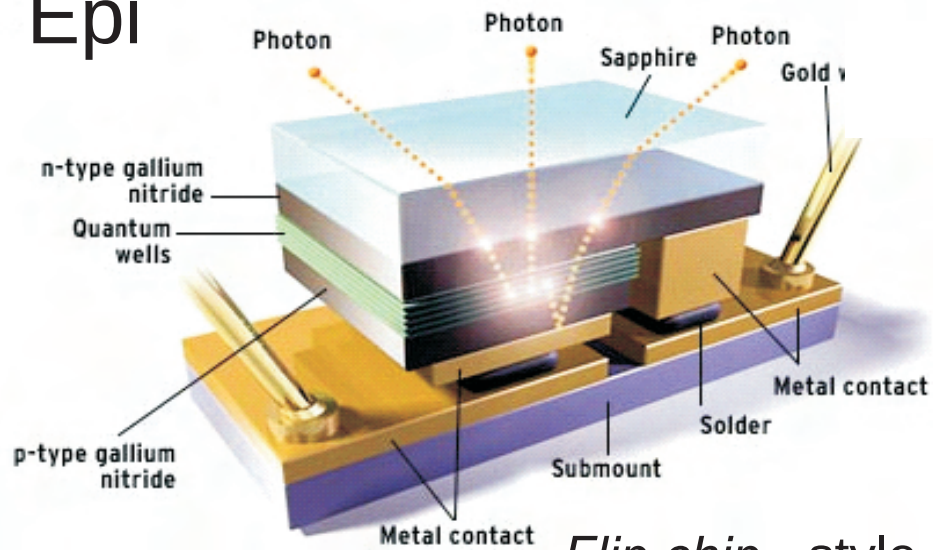
epi - chip - lamp

Chip



PHILIPS
LUMILEDS

Epi



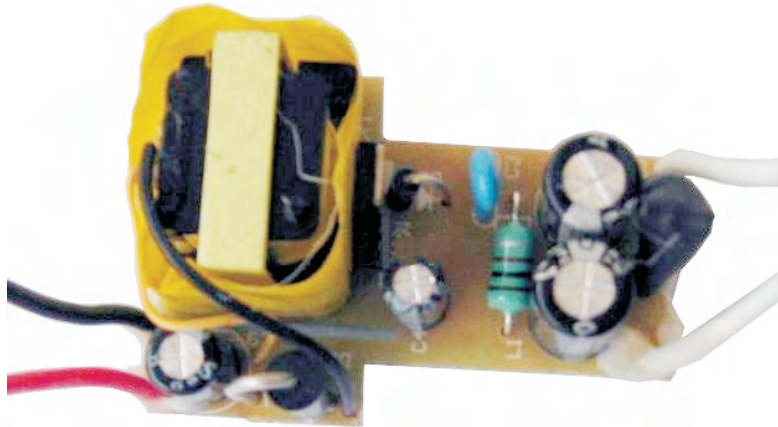
Flip chip - style

Lamp



Periphery

old world technology



+ Driver



+ Cooling

... an awkward BOM (Bill of Materials)

Standard Bulb Replacement

fits the socket

L•PRIZE®
U.S. Department of Energy



Sorraa

MR-16



CREE

PAR-38



Philips

A19

Nostalgia or Progress to Quality of Life?

as seen where people are



EDISON-STYLE BULB

\$15.00

boutique
or
trendsetter?

The Charles F. Lucas
Confectionery & Wine Bar
Troy, NY



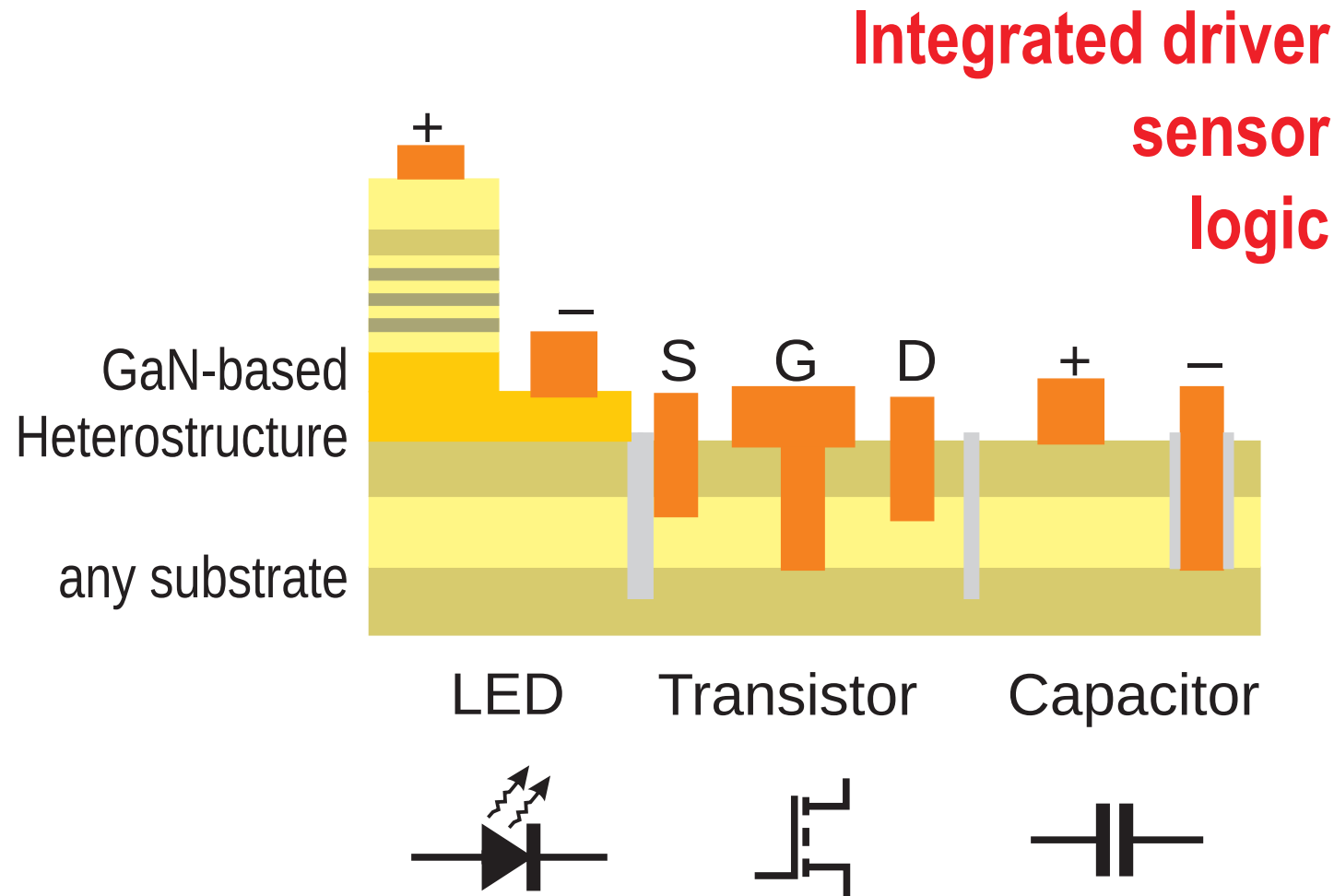
west elm

The Record

Published: Friday, October 26, 2012

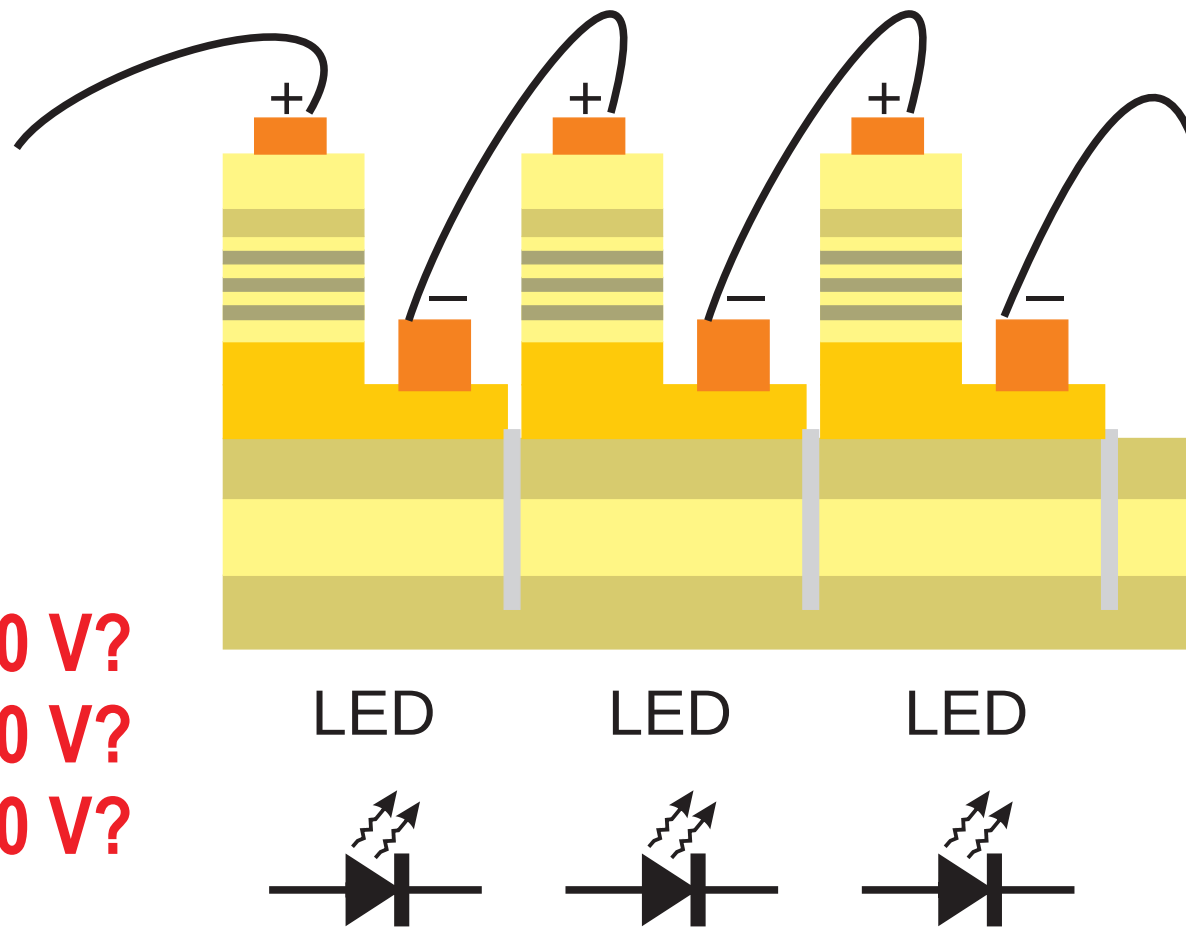
Complete Integration on the Materials Level

the better way to go



High Voltage LED, AC LED

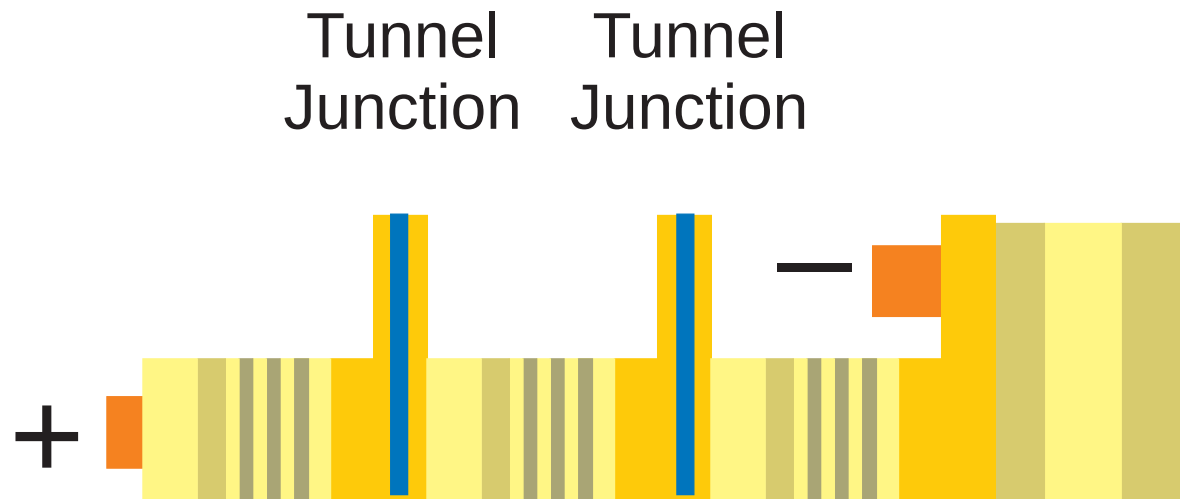
daisy chaining



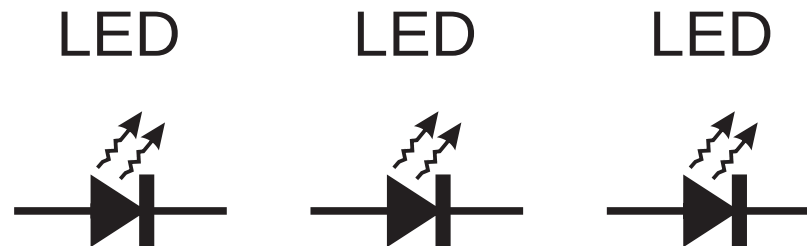
Why not 60 V?
110 V?
240 V?

High Voltage LED, AC LED

daisy chaining



Why not 60 V?
110 V?
240 V?

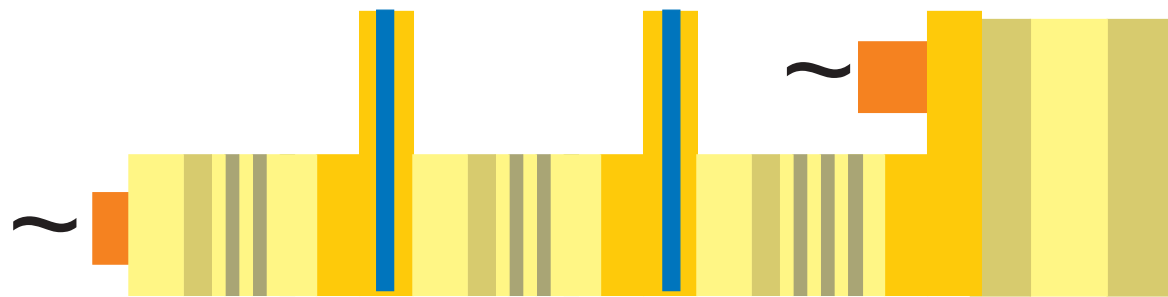


High Voltage LED, AC LED

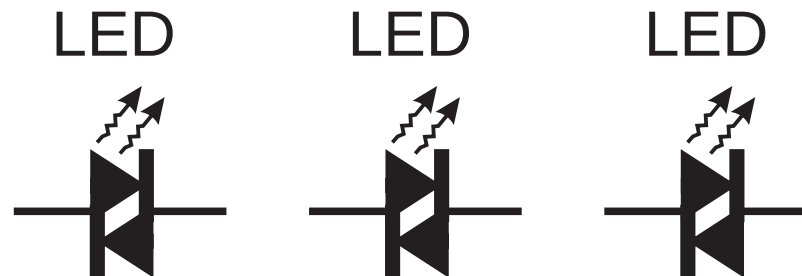
daisy chaining

Reversible
Tunnel
Junction

Reversible
Tunnel
Junction

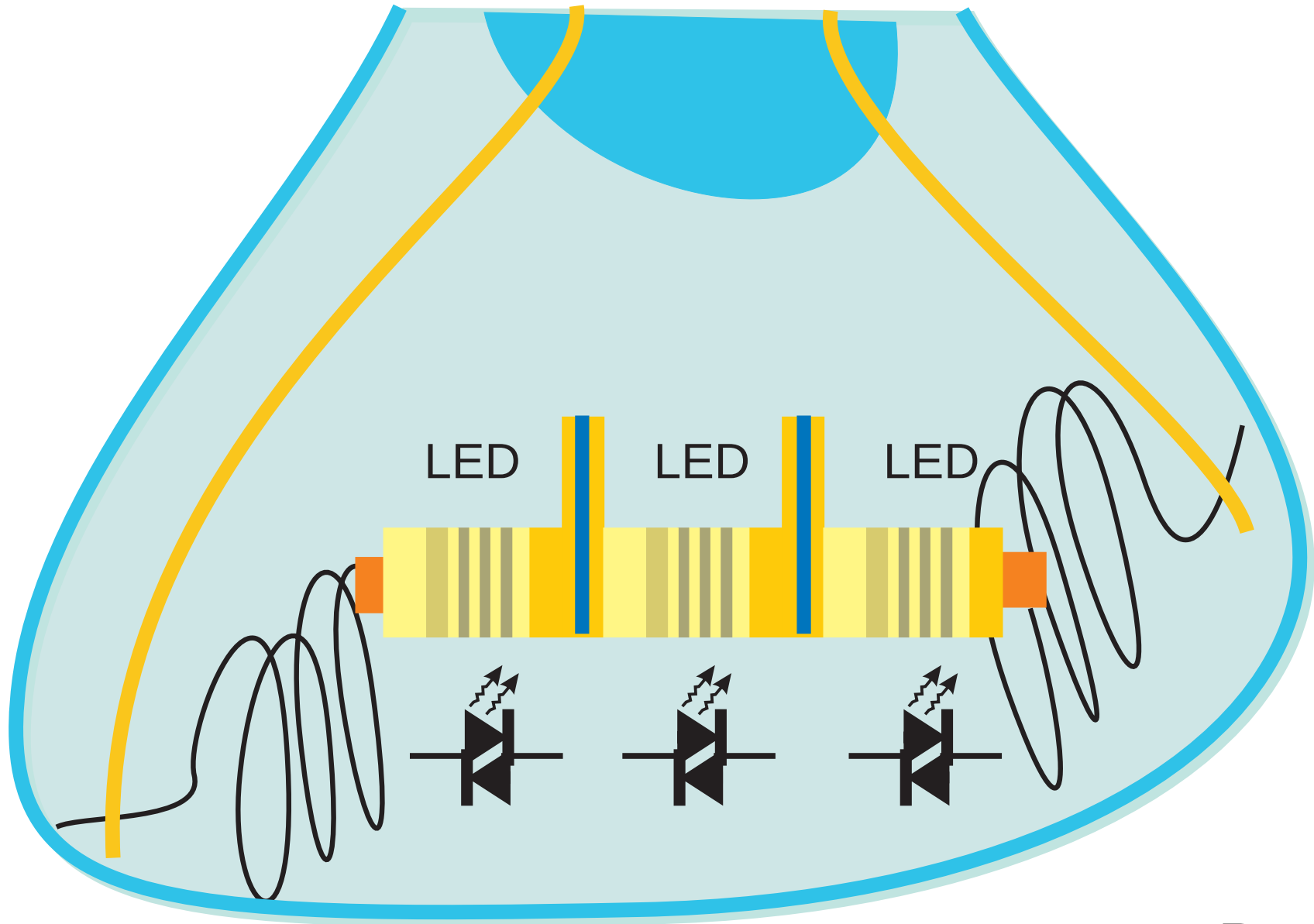


Why not 60 V?
110 V?
240 V?



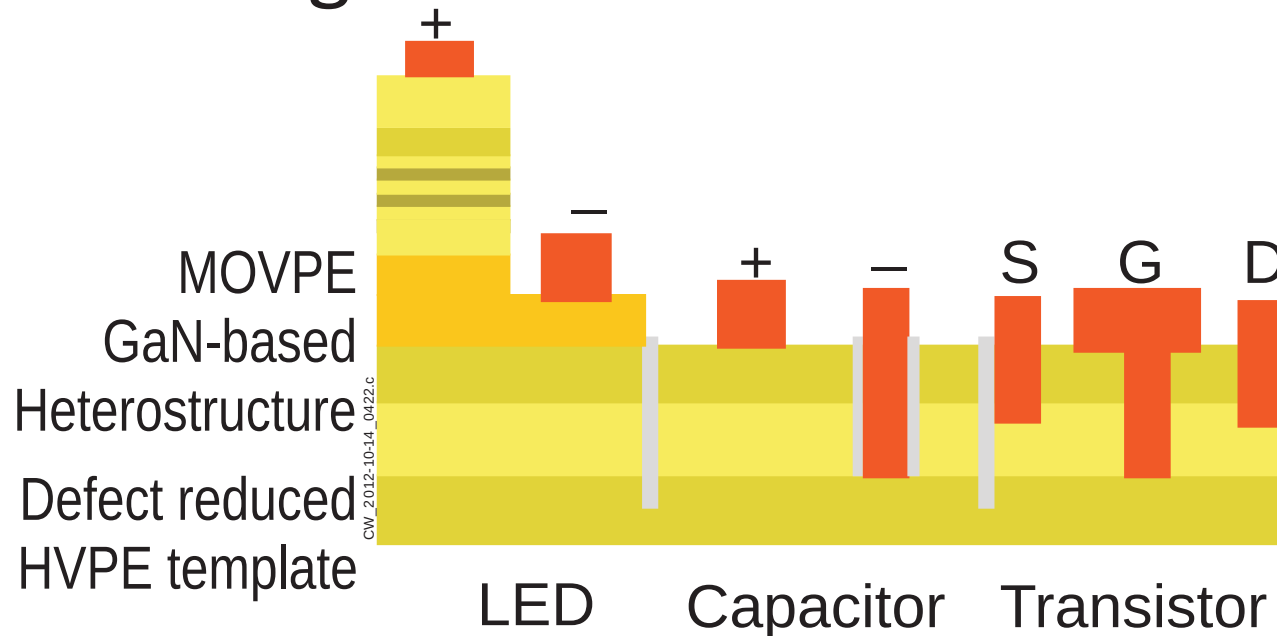
The New Bulb

the way you gonna know it



AC LED System

- Convergence
 - LED + FET,
 - FET + Capacitor
 - Sensors + Logic
- Integration
 - Monolithic
 - Epitaxial
 - Same Materials



Materials Development Needs

- Droop Reduction

=> Higher Efficiency

=> Higher Lumen

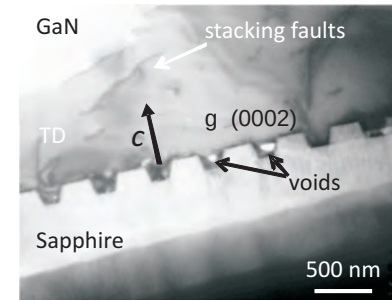
=> Less Cooling

- Integration LED + Phosphor

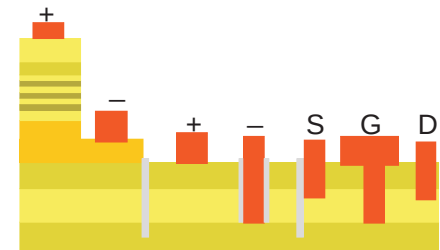
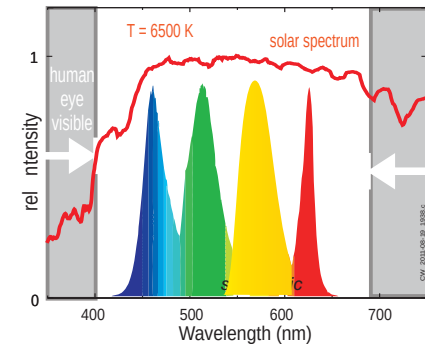
=> Direct Spectrum LED

- Integration LED + Driver + Sensor + Controls

=> AC LED System



Yufeng Li, *et al.*
Appl. Phys. Lett, **98**(15), 151102 (2011)





10th International Conference on Nitride Semiconductors

Christian Wetzel
Jaime A. Freitas, Jr.

Asif Khan – Honorary Chair

Washington DC, USA
August 25-30, 2013

www.icns10.org

expected attendance: >1000

- Bulk Crystal Growth
- Epitaxial Growth
- Optical and Electronic Properties
- Processing and Fabrication
- Defect Characterization and Engineering
- Structural Analysis
- Theory and Simulation
- Nanostructures
- Light Emitting Devices
- Electron Transport Devices
- Photovoltaics and Energy Harvesting
- New Materials and New Device Concepts



Materials Research Society
The Materials Gateway